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# Memory Manager for Linux

Release Note: Software

R-Car H3/M3/M3N/E3 Series

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# How to Use This Manual

- **[Readers]**

This manual is intended for engineers who develop products which use the R-Car H3/M3/M3N/E3 processor.

- **[Purpose]**

This manual is intended to give users an understanding of the functions of the R-Car H3/M3/M3N/E3 processor device driver and to serve as a reference for developing hardware and software for systems that use this driver.

- **[How to Read This Manual]**

It is assumed that the readers of this manual have general knowledge in the fields of electrical

— engineering, logic circuits, microcontrollers, and Linux.

→ Read this manual in the order of the CONTENTS.

— To understand the functions of a multimedia processor for R-Car H3/M3/M3N/E3

→ See the R-Car H3/M3/M3N/E3 User's Manual.

— To know the electrical specifications of the multimedia processor for R-Car H3/M3/M3N/E3

→ See the R-Car H3/M3/M3N/E3 Data Sheet.

- **[Conventions]**

The following symbols are used in this manual.

Data significance: Higher digits on the left and lower digits on the right

**Note:** Footnote for item marked with Note in the text

**Caution:** Information requiring particular attention

**Remark:** Supplementary information

Numeric representation: Binary ... xxxx, 0bxxxx, or xxxxB

Decimal ... xxxx

Hexadecimal ... 0xxxxx or xxxxH

Data type: Double word ... 64 bits

Word ... 32 bits

Half word ... 16 bits

Byte ... 8 bits

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## 1. Introduction

This manual explains the package construction of Memory Manager for Linux and restrictions of the current release.

This software is provided based on the GNU General Public License (GPLv2), MIT License.  
Please handle this software according to the conditions of each license.

## 2. List of Memory Manager Software Contents

The following is included in this software.

### 2.1 Software (Hosted in github.com)

No.	Contents	URL	License
1	Memory Manager (Interface Layer)	<a href="https://github.com/renesas-rcar/mmngr_lib">https://github.com/renesas-rcar/mmngr_lib</a> (ID: 0322548e54b45a064c9cecea29018ef50cdb8423)	MIT
2	Memory Manager (Driver layer)	<a href="https://github.com/renesas-rcar/mmngr_drv">https://github.com/renesas-rcar/mmngr_drv</a> (ID: 2439802426474136312bd10bc4c143fbf1c84850)	MIT / GPLv2

### 2.2 Documentation (Multimedia Reference Software for Linux Doc)

No.	Contents	File name	Version
1	Release Note (This document)	RENESAS_RCH3M3M3NE3_MMP_MMNGR_Linux_ReleaseNote_E_v5.9.0.pdf	5.9.0
2	User's Manual	RENESAS_RCH3M3M3NE3_MMP_MMNGR_Linux_UME_v3.00.pdf	3.00

## 3. Change History

### 3.1 Major updates in previous versions

No.	Description
#77137	Initial R-CarH3 support (v2.2.0).
#84300	Add support for Lossy Decompression feature (v2.8.0)
#94805	Add IPMMU (PMB) support for memory allocation (v2.11.0)

### 3.2 v2.12.0

No.	Description
#97336	Add IPMMU (PMB) registers backup/restore to support System Suspend-to-RAM.

### 3.3 v2.16.0

No.	Description
#103695	Remove duplicated definitions between user and header file
#103676	Remove staging driver
#103933	Add support for Linux v4.9 stable
#108908	Add IPMMU (PMB) support for 40-bit address space of CMA area for Lossy compression

### 3.4 v2.17.0

No.	Description
#112734	Add support for R-Car H3 Ver.2.0
#114933	Add IPMMU (PMB) support for VSPB on R-Car H3 Ver.1.x and M3 Ver.1.0

### 3.5 v2.19.0

No.	Description
#116810	Add support for R-Car M3 Ver.1.1, Ver.1.2

### 3.6 v2.21.0

No.	Description
#117217	Add IPMMU (MMU) support with 1GB page for memory allocation instead of PMB.
#121332	Fix compiler/sparse warnings
#122262	Disable TLB function in IPMMU-VC0/VC1/VP0/VP1 for R-Car H3 Ver.2.0
#123874	Add IPMMU (MMU) registers backup/restore to support System Suspend-to-RAM.
#124339	Add IPMMU (MMU) support for 40-bit address space of CMA area for DTV (SSP)

### 3.7 v2.23.0

No.	Description
#128002	Fix warnings reported by checkpatch and static code analysis tool



**3.8 v2.23.1**

No.	Description
#137570	Add support for R-Car M3N Ver.1.1

**3.9 v3.4.0**

No.	Description
#144845	Add support for Linux v4.14 stable.
#145666	Fix compiler/checkpatch warnings.
#145776	Disable IPMMU TLB cache function in M3N Ver.1.1 due to hardware restriction.
#149416	Update reserved bits handling in IMTTLB and IPMMU (MMU) initialize sequence.

**3.10 v3.6.0**

No.	Description
#144922	Fix warnings reported by static code analysis tool.
#149423	Disable IPMMU TLB cache function in E3 Ver.1.0 due to hardware restriction.
#149999	Change the way of parsing reserved memory regions in DT
#152933	Update IPMMU (MMU) deinitialize sequence
#153165	Add support for R-Car E3 Ver.1.0

**3.11 v3.7.0**

No.	Description
#149466	Disable IPMMU TLB cache function in selected SoC revision
#150847	Disable TLB function on IPMMU-PV1 cache on H3 Ver.2.0 by BL2
#162283	Add H3 Ver.3.0 support
#162844	Update CMA memory mapping for R-Car E3

**3.12 v3.9.0**

No.	Description
#171377	Add support for Linux v4.14.35 (LTSI candidate)

**3.13 v3.9.0.1**

No.	Description
#187322	Fix static analysis warnings

**3.14 v3.15.0**

No.	Description
#142732	Improve error handling for import phases and close() function
#190672	Add support for Linux v4.14-LTSI
#190686	Remove unnecessary check when parsing reserved memory regions in DT
#192478	Disable IPMMU TLB cache function in E3 Ver.1.x due to hardware restriction
#192482	Add E3 Ver.1.1 support
#195715	Add error handling for mm_probe() function

**3.15 v3.19.0**

No.	Description
#203696	Add IPMMU(MMU) support for R-Car M3 Ver.3.0 (Not Verified)

**3.16 v3.21.0**

No.	Description
#217803	Fix dmabuf refcount handling on mm_ioc_import_start() failure
#218172	Remove cache snoop transaction for page table walk request

**3.17 v5.1.0**

No.	Description
#269293	Make sure IPMMU data for H3 Ver.1.x is set correctly
#269293	Don't register as BUS IOMMU if machine doesn't have IPMMU-VMVA
#269293	Fix build errors in kernel version 5.4
#295363	Add kernelheap cached buffers support
#306997	Fix a race between close() and dmabuf_map_dma_buf() callbacks
#306997	Fix build errors in kernel version 5.10

**3.18 v5.5.0**

No.	Description
#320649	Add default coherent DMA mask
#320640	Update IPMMU(MMU) compatible for R8A77961 M3-W+

**3.19 v5.9.0 (This version)**

No.	Description
-	No source code changes

## 4. Restriction

### 4.1 Known issues

There are no known issues.

CMA area for MMP, MMP for DTV (SSP) and Lossy compression can be assigned to 40-bit physical address space when IPMMU MMU support config is enabled.

For details, refer to the following table.

CMAs	40-bit physical address space						
	R-Car H3			R-Car M3		R-Car M3N	R-Car E3
	Ver.1.x	Ver.2.0	Ver.3.0	Ver.1.x	Ver.3.0	Ver.1.x (*1)	Ver.1.x (*2)
Default CMA area	-	-	-	-	-	-	-
CMA area for MMP	Support	Support	Support	Support	Support	-	-
CMA area for MMP for DTV (SSP)	Support	Support	Support	Support	Support	-	N/A
CMA area for Lossy compression	Support	Support	Support	Support	Support	-	-

\*1: On M3N, there's no 40-bit physical address space. Therefore, CMA areas are kept in legacy area.

\*2: On E3:

- There's no 40-bit physical address space. Therefore, CMA areas are kept in legacy area.
- It does not support DTV (SSP) feature, so the space reserved as CMA area for MMP for DTV (SSP) is not available.
- Lossy compression feature is only available on Board Ebisu-4D.

### 4.2 Workaround

- **[H/W Restriction No.71 #9]**

When the addresses from multiple translation requests consecutively hit TLB entries in the IPMMU(cache) (used for a single domain), addresses are either incorrectly translated or stalling condition is being reached.

----

- R-Car M3 Ver.1.x  
The software workaround is unnecessary because TLB function of all IPMMU caches is disabled by hardware.
- R-Car H3 Ver.1.x  
The software workaround is to use 1GB page size so that all of page table entries are fully cached in a uTLB. Thus, preventing a page fault makes it possible to use two or more master IPs in IPMMU-VP.
- R-Car H3 Ver.2.0  
The software workaround is to disable TLB function of all IPMMU caches.

The followings are shown that Memory manager disables TLB function of IPMMU caches which belong to A3VP and A3VC power domain and IPL does the function of IPMMU caches which belong to always-on power domain.

IPMMU cache	Power Domain	IPL	Memory Manager
IPMMU-VI0	Always-on	✓	-
IPMMU-VI1	Always-on	✓	-
IPMMU-VP0	A3VP	-	✓
IPMMU-VP1	A3VP	-	✓
IPMMU-VC0	A3VC	-	✓
IPMMU-VC1	A3VC	-	✓
IPMMU-PV0	Always-on	✓	-
IPMMU-PV1	Always-on	✓	-
IPMMU-PV2	Always-on	✓	-
IPMMU-PV3	Always-on	✓	-
IPMMU-IR	A3IR	- (*1)	- (*1)
IPMMU-HC	Always-on	✓	-
IPMMU-RT	Always-on	✓	-
IPMMU-MP	Always-on	✓	-
IPMMU-DS0	Always-on	✓	-
IPMMU-DS1	Always-on	✓	-

\*1: A user need to disable TLB function of IPMMU caches which belong to A3IR.

● **[H/W Restriction No.100]**

When the timing of entry replacement of the TLB cache in the hierarchical IPMMU and the TLB flush occur at the same time, the address translation information may not be returned correctly in some cases.

----

- R-Car H3 Ver.1.x  
The software workaround is same as [No.71 #9].
- R-Car H3 Ver.2.0  
The software workaround is same as [No.71 #9].
- R-Car M3 Ver.1.x  
The software workaround is same as [No.71 #9].
- R-Car M3N Ver.1.1  
The software workaround is to disable TLB function of all IPMMU caches.

The followings are shown that on R-Car M3N Ver.1.1, Memory manager disables TLB function of IPMMU caches which belong to A3VP and A3VC power domain and IPL disables the function of IPMMU caches which belong to always-on power domain.

IPMMU cache	Power Domain	IPL	Memory Manager
IPMMU-VI0	Always-on	✓	-
IPMMU-VP0	A3VP	-	✓
IPMMU-VC0	A3VC	-	✓
IPMMU-PV0	Always-on	✓	-
IPMMU-HC	Always-on	✓	-
IPMMU-RT	Always-on	✓	-
IPMMU-MP	Always-on	✓	-
IPMMU-DS0	Always-on	✓	-
IPMMU-DS1	Always-on	✓	-

➤ R-Car E3 Ver.1.x

The software workaround is to disable TLB function of all IPMMU caches.

The followings are shown that on R-Car E3 Ver.1.x, Memory manager disables TLB function of IPMMU caches which belong to A3VC power domain and IPL disables the function of IPMMU caches which belong to always-on power domain.

IPMMU cache	Power Domain	IPL	Memory Manager
IPMMU-VI0	Always-on	✓	-
IPMMU-VP0	Always-on	✓	-
IPMMU-VC0	A3VC	-	✓
IPMMU-PV0	Always-on	✓	-
IPMMU-HC	Always-on	✓	-
IPMMU-RT	Always-on	✓	-
IPMMU-MP	Always-on	✓	-
IPMMU-DS0	Always-on	✓	-
IPMMU-DS1	Always-on	✓	-

**4.3 Closed issues**

- **[H/W Restriction No.59]**

The master IPs which are in the same bus domain hierarchy cannot use PMB and MMU function at the same time.  
----

Regarding 40-bit physical address space support, we no longer make use of PMB function.  
So, this restriction is not applicable.

- **[H/W Restriction No.71 #4]**

The address translation processing in the identical hierarchy when uTLB which uses a PMB change exists, more than one, when it forms, there is a possibility which causes a mis-conversion and a stall.  
----

Regarding 40-bit physical address space support, we no longer make use of PMB function.  
So, this restriction is not applicable.

**4.4 Known functional limitations of delivered functions**

None.

**4.5 Non-validated function**

None.

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REVISION HISTORY		Memory Manager for Linux Release Note: Software	
Rev.	Date	Description	
		Page	Summary
2.12.0	Aug. 2016	—	New version
2.16.0	Jan. 2017	2	Update commit ID and document version
		3	Add Section 3.3
		4	Because of adding IPMMU (PMB) support for 40 bit address space of CMA area for Lossy compression, <ul style="list-style-type: none"> <li>- Change the description in section 4.1</li> <li>- Update the table in section 4.1</li> <li>- Add the description in section 4.3</li> </ul>
2.17.0	Mar. 2017	2	Update commit ID and document version
		3	Add Section 3.4
		4	Due to [H/W Restriction No.71 #4], <ul style="list-style-type: none"> <li>- Change the description in section 4.1</li> <li>- Update the table in section 4.1</li> <li>- Delete the description in section 4.3</li> </ul>
2.19.0	Apr. 2017	2	Update document version
		3	Add Section 3.5
		4	Update the table in Section 4.1
2.21.0	Jun. 2017	2	Update commit ID and document version
		3	Add Section 3.6
		4	Update the table in Section 4.1
		4	Add [H/W Restriction No.71 #9] in Section 4.2
		4	Move [H/W Restriction No.59] and [H/W Restriction No.71 #4] in Section 4.3
2.23.0	Aug. 2017	2	Update commit ID and document version
		3	Add Section 3.7
2.23.1	Nov. 2017	2	Update commit ID and document version
		4	Add Section 3.8
		5	Update the table in Section 4.1 for M3N
3.4.0	Jan. 2018	2	Update commit ID and document version
		4	Add Section 3.9
		5, 6	Update [H/W Restriction No.71 #9] in Section 4.2
		6, 7	Add [H/W Restriction No.100] in Section 4.2
3.6.0	Mar. 2018	2	Update commit ID and document version
		4	Add Section 3.10
		5	Update the table in Section 4.1 for E3
		6, 7	Update [H/W Restriction No.100] in Section 4.2
3.7.0	Apr. 2018	2	Update commit ID and document version
		4	Add Section 3.11
		5	Update the table in Section 4.1 for H3 Ver.3.0
		5	Update Notices about space reserved as CMA area for Lossy compression feature on R-Car E3
3.9.0	Jun. 2018	2	Update document version
		3, 14	Revise M3 SoC revision information
		4	Revise M3N SoC revision information
		4	Add Section 3.12
3.9.0.1	Oct. 2018	2	Update commit ID and document version
		4	Add Section 3.13

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3.15.0	Dec. 2018	—	Update Address List
		2	Update commit ID and document version
		5	Add Section 3.14
		6	Update the table in Section 4.1 for E3 Ver.1.1
		6	Update Notices about space reserved as CMA area for Lossy compression feature on R-Car E3
		7, 8	Update IPMMU caches information in H/W restriction No.71 #9 and No.100
3.19.0	Apr. 2019	—	Update Address List
		2	Update commit ID and document version
		5	Add Section 3.15
		6	Update the table in Section 4.1
3.21.0	Jun. 2019	2	Update commit ID and document version
		5	Add Section 3.16
		6	Update the table in Section 4.1
5.1.0	Apr. 21, 2021	—	Update Address List
		2	Update commit ID and document version
		5	Add Section 3.17
5.5.0	Aug. 26, 2021	2	Update commit ID
		5	Add Section 3.18
5.9.0	Dec.10, 2021	—	Update Notice
		2	Update commit ID and document version
		5	Add Section 3.19



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# Memory Manager for Linux

## Release Note: Software



Renesas Electronics Corporation